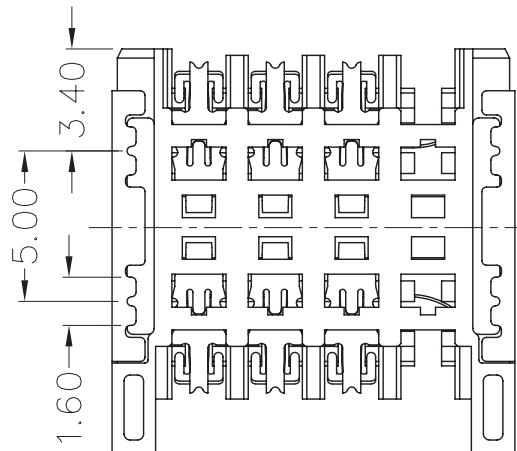
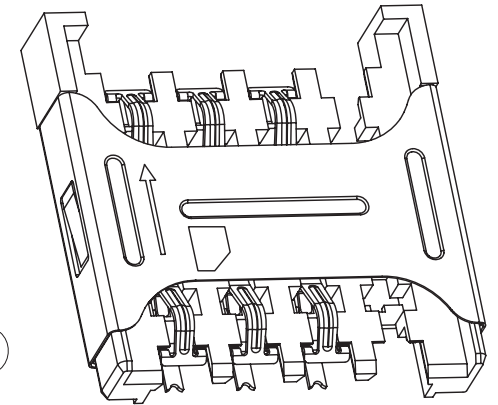
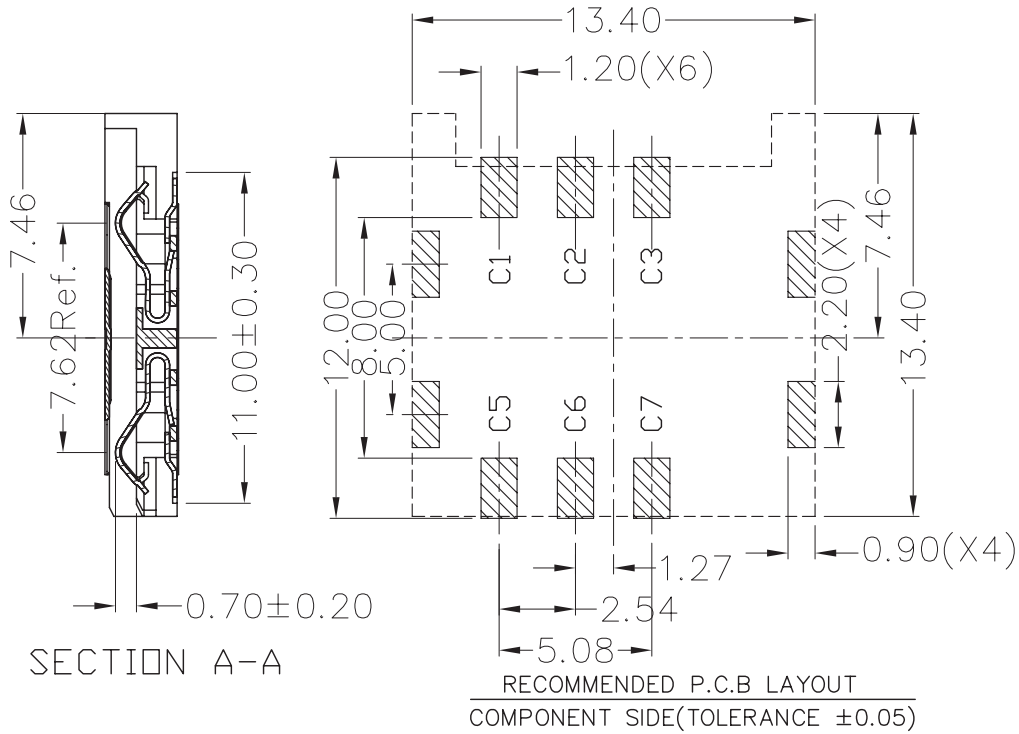
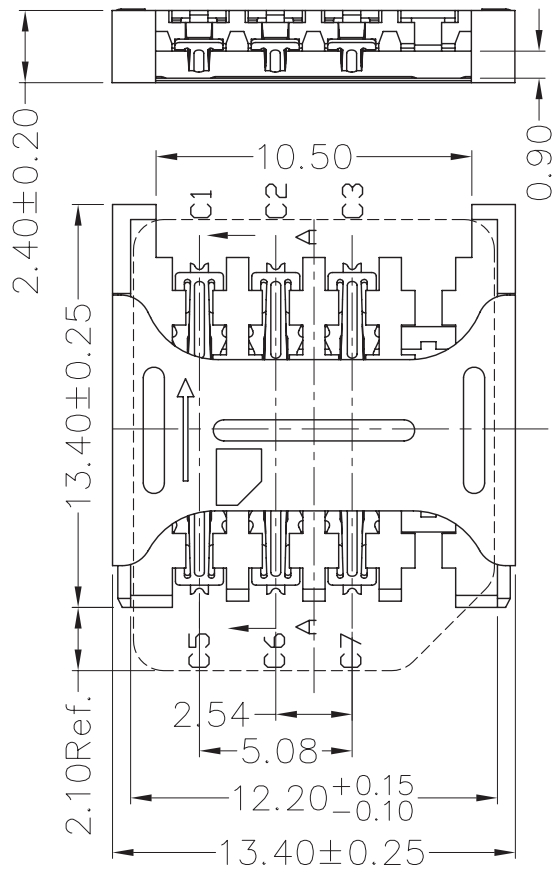


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



SECTION A-A

RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE(TOLERANCE ±0.05)

TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions: 13.40LX13.40WX2.40H mm

Weight: Approx 0.40±0.1g

Durability: 5,000 cycles min.

2.Electrical Characteristics

Contact resistance: 50mΩ typical, 100mΩ max

Insulation resistance: >1000MΩ/500V DC

3.Solderability

Vapor phase: 215°C, 30sec. Max

IR reflow: 250°C, 5sec. Max

Manual soldering: 370°C, 3sec. Max

4.Environmental Characteristics

Operating temperature: -40°C~+85°C

Operating humidity: 10%~+95%RH

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	BASE	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area: Gold plated
3	SHELL	1	Stainless steel	SMT area: Gold plated

Unless otherwise specified, other tolerance are:			<h1>Wellco T&C Co., Ltd.</h1>		
X	±0.35	X'			±5'
X.X	±0.25	X.X'			±4'
X.XX	±0.15	X.XX'			±3'
X.XXX	±0.10	X.XXX'	±2'		
NAME:			Micro-SIM Card Connector		
MODEL NO:			790		
TYPE :			6Pin H=2.40 mm		
PROJ.	UNIT	SCALE	DRAWN	Zoey Mar.04.2011	
⊕	MM	1:1	CHECKED	Sean Mar.04.2011	
CUSTOMER DRAWING			APPROVAL	Simon Mar.04.2011	
			DWG NO.:	790-001	
			SHEET	1/1	
			REVISION	X1	

